## **DETAILED ACTION**

This second non-final action is in response to the amendment filed 09/18/2009. Claims 4, 16, & 27-33 are pending and have been considered as follows.

## Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 4, 16, & 27-33 are rejected under 35 U.S.C. 103(a) as being unpatentable over <u>Sugasawara</u> (US-6043672-A) in view of <u>Beasley et al.</u> ("iDD pulse response testing applied to complex CMOS ICs").

Claims 4 & 16:

<u>Sugasawara</u> discloses a fault analysis method of presuming a fault location of a semiconductor IC and a fault analysis apparatus configured to presume a fault location of a semiconductor IC comprising,

- "applying a power supply voltage to said semiconductor IC" (i.e. "A selectable power supply line for providing power to a particular section of the integrated circuit is activated by an enable signal provided to a selectable power supply switch coupled to the selectable power supply line") [column 3 lines 28-32];

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- "supplying a test pattern sequence having a plurality of test patterns to said semiconductor IC" (i.e. "Test development strategies include functional test wherein automatic test equipment (ATE) test programs are performed in which the circuit under test is stimulated with specified inputs while the outputs are monitored to determine if they correspond with simulated logic values") [column 1 lines 54-58];

- "the electrical potentials at the one or more locations are expected to change once the test pattern sequence is supplied" (i.e. "Defects in integrated circuits take many forms, some of which are test pattern sensitive...Quiescent current tests differ in that current is sensed rather than voltage, providing a simple means to monitor the entire circuit or portions thereof for over-current conditions") [column 1 lines 64-65 & column 2 lines 25-28];
- "measuring a time integral of a transient power supply current generated on said semiconductor IC in accordance with the change of said test pattern" (i.e. "Once halted (i.e., no transistor state switching is occurring) the power supply of the device under test is measured by the ATE and the resulting value is compared to predetermined reference values or test limits") [column 2 lines 14-18];
- "determining whether said transient current shows abnormality or not" (i.e. "the device under test is measured by the ATE and the resulting value is compared to predetermined reference values or test limits. Such quiescent current tests are effective in detecting many faults that would otherwise not be found by other test strategies") [column 2 lines 16-20];

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2 lines 49-53];

- "presuming a fault location out of said fault location list based on said test pattern sequence" (i.e. "This approach has typically included measuring current in a region of the integrated circuit, cutting lines to sections within the same region other than the section of interest, and then taking a additional measurements of current in the region") [column

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- "the transient power supply current shows abnormality and said fault location list" (i.e. "In order to isolate the defective area of an integrated circuit, a failure analysis engineer seeks to determine which section of the integrated circuit is responsible for unusual current levels") [column 2 lines 38-41];
- "said transient power supply current is determined to be abnormal in a case that the time integral of said transient power supply current is over a predetermined value in said step of determining" (i.e. "In order to isolate the defective area of an integrated circuit, a failure analysis engineer seeks to determine which section of the integrated circuit is responsible for unusual current levels") [column 2 lines 38-41];

but, Sugasawara does not explicitly disclose,

- "storing a fault location list for the test pattern sequence," although <u>Sugasawara</u> does
  suggest an automated test equipment that would store test pattern sequences and which
  portions of the semiconductor integrated circuit have been isolated for testing, as recited
  below;
- "the fault location list includes one or more locations of components in said IC," although

  <u>Sugasawara</u> does suggest several components of a semiconductor integrated circuit that

  are tested for defects, as recited below;

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- "said presuming comprises: deleting analysis points corresponding to the test pattern sequence where the transient power supply current does not show abnormality from analysis points corresponding to the test pattern sequence where the transient power supply current shows abnormality," although <u>Beasley et al.</u> do suggest determining which circuit tests result in a fault, as recited below;
- "presuming a remaining analysis point out of the analysis points corresponding to the test pattern sequence where the transient power supply current shows abnormality to be a fault location," although <u>Beasley et al.</u> do suggest determining which circuits are defective based on the completed fault tests, as recited below;

however, Sugasawara does disclose,

- "automated test equipment (ATE)" [column 5 line 11];
- "CMOS circuits use complementary p-channel metal-oxide-semiconductor field-effect (PMOS) transistors and n-channel metal-oxide-semiconductor field-effect (NMOS) transistors... Gate oxide defects, drain to source current leaks (punch-through), and p-n junction current leaks (such as drain or source to diffusion current leaks)" [column 1 lines 36-39, 66-67 & column 2 line 1];

whereas, Beasley et al. do disclose,

- "...Table 2 SME scoring of the iDDPRT Time-Domain Tests for the SA3865. The time-domain tests performed up to this point for the SA3865 show limited success for detecting functional failures. While the success rate (85.7%) is promising, it is not satisfactory for full device screening in a manufacturing environment. Four functional failures were misclassified as "Good." On the other hand, 11 of the 15 functional failures

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were successfully removed from the test lot without requiring additional expensive test time. The time-domain tests for the SA3865 provided the following useful results: the iDDPRT test shows good promise for detecting functional failures...the iDDPRT time domain analysis technique used in this test was not suitable for detecting IDDQ failures...Since this analysis is described by a simple equation, and can be performed rapidly, it has the potential to be implemented in a production test program..." [page 34]; Therefore, it would have been obvious for one of ordinary skill in the art at the time of the applicant's invention to include, "storing a fault location list for the test pattern sequence" and "the fault location list includes one or more locations of components in said IC" and "said presuming comprises: deleting analysis points corresponding to the test pattern sequence where the transient power supply current does not show abnormality from analysis points corresponding to the test pattern sequence where the transient power supply current shows abnormality" and "presuming a remaining analysis point out of the analysis points corresponding

corresponding to the test pattern sequence where the transient power supply current shows abnormality" and "presuming a remaining analysis point out of the analysis points corresponding to the test pattern sequence where the transient power supply current shows abnormality to be a fault location," in the invention as disclosed by <u>Sugasawara</u> since predetermined reference values or test limits would typically be stored within the testing device in order to be compared to the resulting value(s) and for the purposes of determining which circuits are defective/faulty using the processing of elimination as would be obvious to one of ordinary skill in the art.

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Claim 27:

<u>Sugasawara</u> discloses a fault analysis apparatus configured to presume a fault location of semiconductor IC comprising,

- "a power supply configured to apply a power supply voltage to said semiconductor IC" (i.e. "A selectable power supply line for providing power to a particular section of the integrated circuit is activated by an enable signal provided to a selectable power supply switch coupled to the selectable power supply line") [column 3 lines 28-32];
- "a test pattern sequence input unit configured to supply a test pattern sequence comprising a plurality of test patterns to said semiconductor IC" (i.e. "Test development strategies include functional test wherein automatic test equipment (ATE) test programs are performed in which the circuit under test is stimulated with specified inputs while the outputs are monitored to determine if they correspond with simulated logic values") [column 1 lines 54-58];
- rather than voltage, providing a simple means to monitor the entire circuit or portions thereof for over-current conditions") [column 1 lines 64-65 & column 2 lines 25-28];
- "an integral transient power supply current measuring unit configured to measure a time integral of a transient power supply current generated on said semiconductor IC in accordance with the change of said test pattern" (i.e. "Once halted (i.e., no transistor state

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switching is occurring) the power supply of the device under test is measured by the ATE and the resulting value is compared to predetermined reference values or test limits")

[column 2 lines 14-18];

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- "a fault detector configured to determine that said transient power supply current is abnormal in a case that the time integral of said transient power supply current is over a predetermined value" (i.e. "the device under test is measured by the ATE and the resulting value is compared to predetermined reference values or test limits. Such quiescent current tests are effective in detecting many faults that would otherwise not be found by other test strategies") [column 2 lines 16-20];
- "a fault location presuming unit configured to presume a fault location out of said fault location list based on said test pattern sequence" (i.e. "This approach has typically included measuring current in a region of the integrated circuit, cutting lines to sections within the same region other than the section of interest, and then taking a additional measurements of current in the region") [column 2 lines 49-53];
- "the transient power supply current shows abnormality and said fault location list" (i.e. "In order to isolate the defective area of an integrated circuit, a failure analysis engineer seeks to determine which section of the integrated circuit is responsible for unusual current levels") [column 2 lines 38-41];

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but, Sugasawara does not explicitly disclose,

- "a fault location list memory unit configured to store a fault location list for the test pattern sequence," although <u>Sugasawara</u> does suggest an automated test equipment that would store test pattern sequences and which portions of the semiconductor integrated circuit have been isolated for testing, as recited below;

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- "the fault location list includes one or more locations of components in said IC," although

  Sugasawara does suggest several components of a semiconductor integrated circuit that

  are tested for defects, as recited below;
- "said fault location presuming unit is configured to presume the fault location by:

  deleting analysis points corresponding to the test pattern sequence where the transient

  power supply current does not show abnormality from analysis points corresponding to
  the test pattern sequence where the transient power supply current shows abnormality,"

  although Beasley et al. do suggest determining which circuit tests result in a fault, as
  recited below;
- "presuming a remaining analysis point out of the analysis points corresponding to the test pattern sequence where the transient power supply current shows abnormality to be a fault location," although <u>Beasley et al.</u> do suggest determining which circuits are defective based on the completed fault tests,, as recited below;

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however, Sugasawara does disclose,

- "automated test equipment (ATE)" [column 5 line 11];

- "CMOS circuits use complementary p-channel metal-oxide-semiconductor field-effect (PMOS) transistors and n-channel metal-oxide-semiconductor field-effect (NMOS) transistors... Gate oxide defects, drain to source current leaks (punch-through), and p-n junction current leaks (such as drain or source to diffusion current leaks)" [column 1 lines 36-39, 66-67 & column 2 line 1];

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whereas, Beasley et al. do disclose,

"...Table 2 SME scoring of the iDDPRT Time-Domain Tests for the SA3865. The time-domain tests performed up to this point for the SA3865 show limited success for detecting functional failures. While the success rate (85.7%) is promising, it is not satisfactory for full device screening in a manufacturing environment. Four functional failures were misclassified as "Good." On the other hand, 11 of the 15 functional failures were successfully removed from the test lot without requiring additional expensive test time. The time-domain tests for the SA3865 provided the following useful results: the iDDPRT test shows good promise for detecting functional failures...the iDDPRT time domain analysis technique used in this test was not suitable for detecting IDDQ failures...Since this analysis is described by a simple equation, and can be performed rapidly, it has the potential to be implemented in a production test program..." [page 34];

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Therefore, it would have been obvious for one of ordinary skill in the art at the time of the applicant's invention to include, "a means for storing a fault location list for the test pattern sequence" and "a fault location list memory unit configured to store a fault location list for the test pattern sequence" and "said fault location presuming unit is configured to presume the fault location by: deleting analysis points corresponding to the test pattern sequence where the transient power supply current does not show abnormality from analysis points corresponding to the test pattern sequence where the transient power supply current shows abnormality" and "presuming a remaining analysis point out of the analysis points corresponding to the test pattern sequence where the transient power supply current shows abnormality to be a fault location," in the invention as disclosed by Sugasawara since predetermined reference values or test limits

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Claims 28-30:

<u>Sugasawara</u> and <u>Beasley et al.</u> disclose a fault analysis method of presuming a fault location of a semiconductor IC, a fault analysis apparatus configured to presume a fault location of a semiconductor IC, and a fault analysis apparatus configured to presume a fault location of semiconductor IC, as in Claims 4, 16, & 27 above, their combination further comprising,

would typically be stored within the testing device in order to be compared to the resulting

value(s) and for the purposes of which circuits are defective/faulty using the processing of

elimination as would be obvious to one of ordinary skill in the art.

- "the semiconductor IC is a CMOS IC" (i.e. "... CMOS ICs...") [Beasley et al. page 32].

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Claims 31-33:

<u>Sugasawara</u> and <u>Beasley et al.</u> disclose a fault analysis method of presuming a fault location of a semiconductor IC, a fault analysis apparatus configured to presume a fault location of a semiconductor IC, and a fault analysis apparatus configured to presume a fault location of semiconductor IC, as in Claims 28-30 above, their combination further comprising,

- "the time integral of said transient power supply current is a sum of integrals of transient currents that flow in logic gates of the CMOS IC" (i.e. "...The observed (oi) iDDPRT generated power-on transient current for each of the ICs in the SA3865 test lot were then compared to the expected (q) power-on transient current response using Eq. 1...") [page 33].

## Response to Arguments

3. Applicant's arguments, see page 2, filed 09/18/2009, with respect to the rejection(s) of claim(s) 4, 16, & 27-33 under 35 U.S.C. 103(a) have been fully considered and are persuasive. Therefore, the rejection has been withdrawn. However, upon further consideration, a new ground(s) of rejection is made in view of previously applied prior art in view of newly found prior art.

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## Conclusion

4. The prior art made of record and not relied upon is considered pertinent to the applicant's disclosure.

- a. <u>Beasley et al.</u> (US-5483170) integrated circuit fault testing implementing voltage supply rail pulsing and corresponding instantaneous current response analysis;
- b. <u>Sachdev et al.</u> ("Defect detection with transient current testing and its potential for deep submicron CMOS ICs");
- 5. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Examiner Oscar Louie whose telephone number is 571-270-1684. The examiner can normally be reached Monday through Thursday from 7:30 AM to 4:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nasser Moazzami, can be reached at 571-272-4195. The fax phone number for Formal or Official faxes to Technology Center 2400 is 571-273-8300.

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PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/OSCAR A LOUIE/ 01/07/2010

/Nasser Moazzami/ Supervisory Patent Examiner, Art Unit 2436